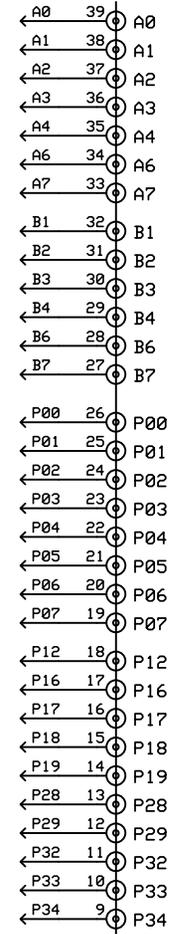
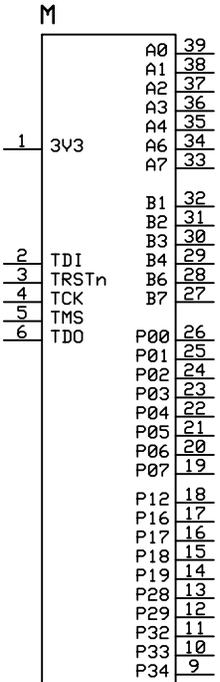
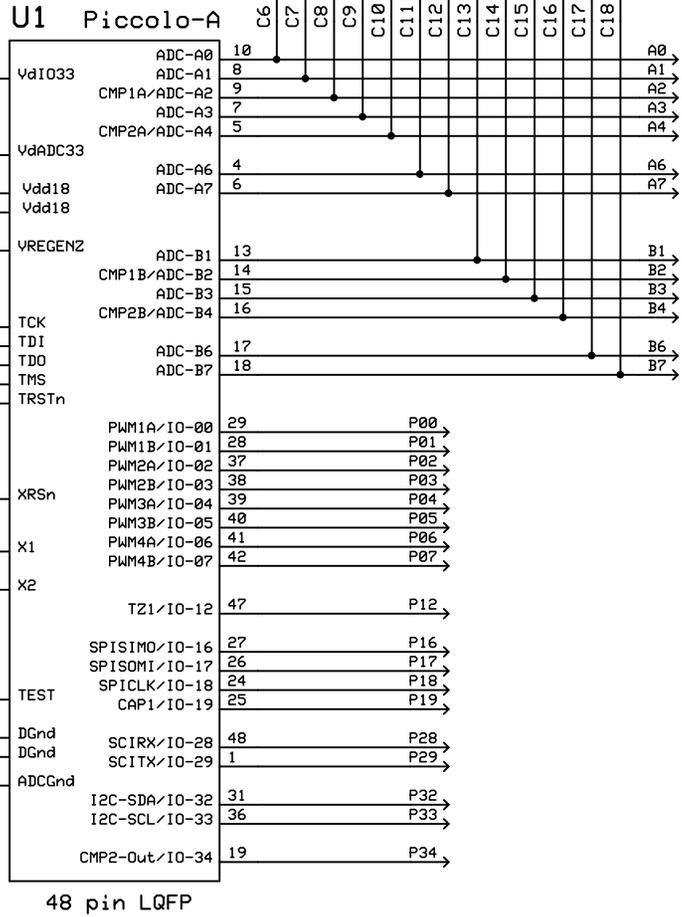
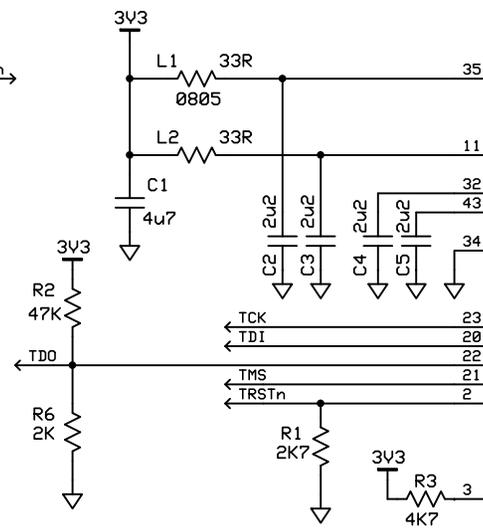
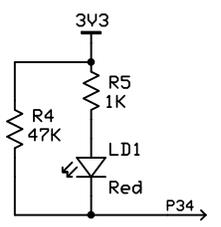
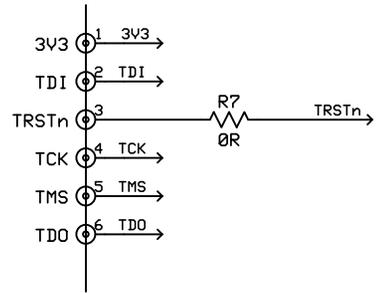


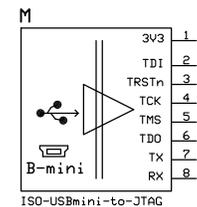
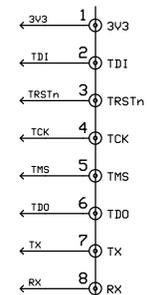
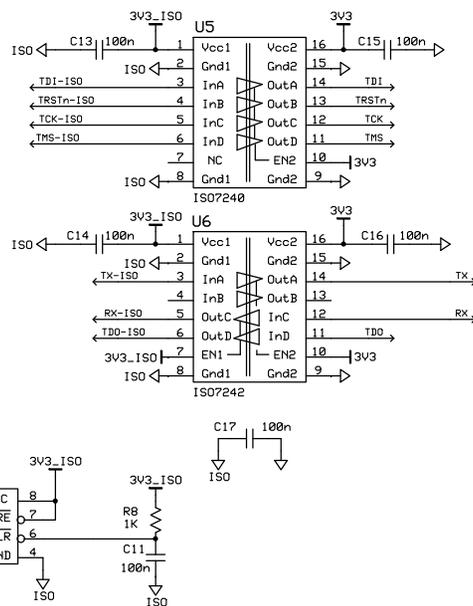
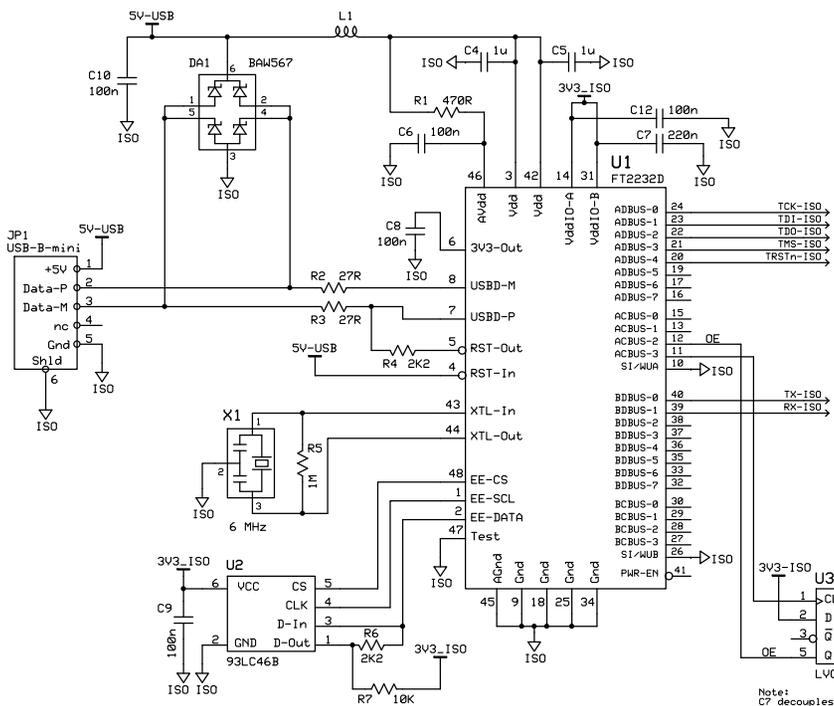
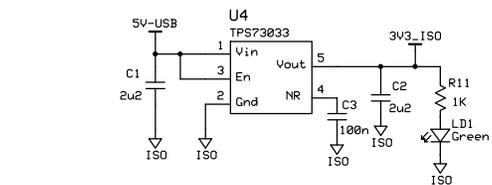
FlashBoot - R6 remove
 SCIBoot - R6 populate
 (in both cases remove R7)



Piccolo-A-48LQFP

GPIO34 TDO TRST
 SCI boot - 1 0 0
 Flash boot - 1 1 0

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Piccolo-A-48-LQFP (macro)		
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Symbol

Texas Instruments		
ISO-USBmini-to-JTAG		
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